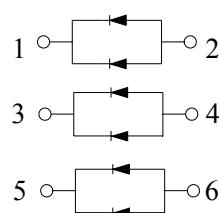
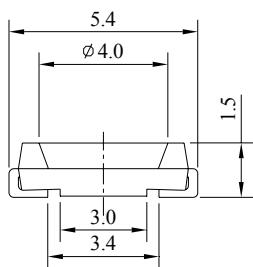
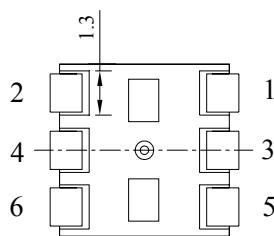
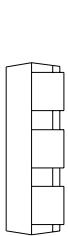
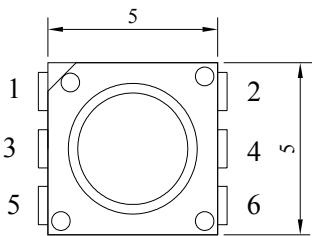


5.0 x 5.0 x 1.5mm SMD Type

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Package Dimensions:



* All dimensions are in mm
* Tolerance: $\pm 0.25\text{mm}$ unless otherwise noted.

Ant Part No.	LED Chip		Lens Colour
	Material	Emitting Colour	
703-1044	AlGaInP/Sapphire	Warm White	Water Clear

Absolute Maximum Ratings at $T_a=25^\circ\text{C}$:

Parameter	Symbol	Rating	Unit
Power Dissipation*	P_D	120	mW
Reverse Voltage*	V_R	5	V
D.C. Forward Current*	I_F	30	mA
Peak Current (1% Duty Cycle, 0.1ms Pulse Width)*	$I_F(\text{Peak})$	100	mA
Operating Temperature Range	$T_{opr.}$	-40 to +100	°C
Storage Temperature Range	$T_{stg.}$	-40 to +100	°C
Soldering Temperature	$T_{sld.}$	Dip Soldering: 260°C for 10sec. Hand Soldering: 350°C for 3sec.	
Electric Static Discharge Threshold (HBM)*	ESD	6000	V

* The values are based on 1 die performance.

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Electrical & Optical Characteristics:

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
Luminous Intensity* ²	lv	IF=40 mA* ³	4800	10280	-	mcd
Luminous Flux* ²	Φv	IF=40 mA* ³	-	23200	-	mlm
Forward Voltage* ³	Vf	IF=40 mA* ³	-	3.2	4.0	V
Correlated Colour Temperature* ²	25	CCT	2500	-	2600	K
	26		2600	-	2700	
	27		2700	-	2900	
Reverse Current* ¹	Ir	Vr=5V* ³	-	-	50	μA
View Angle* ²	2θ½	IF=40 mA* ³	-	120	-	deg

Notes: 1. The data is tested by an IS tester.

2. Customer's special requirements are also welcome.

3. *¹ for each die.

4. *² when all LED dies are operated simultaneously.

5. *³ for one circuit.

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5.0 x 5.0 x 1.5mm SMD Type

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Typical Electrical/Optical Characteristic Curves:

(25°C Ambient Temperature unless otherwise noted)

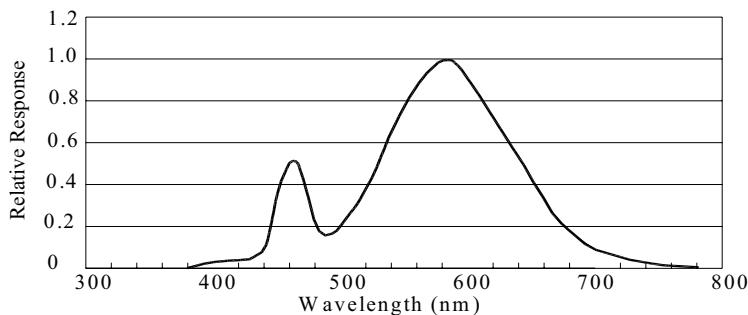
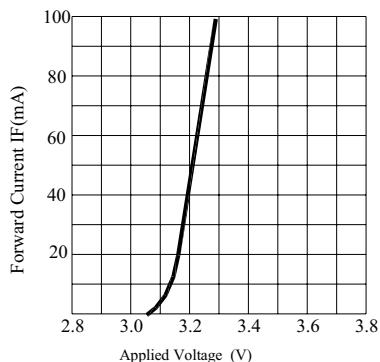
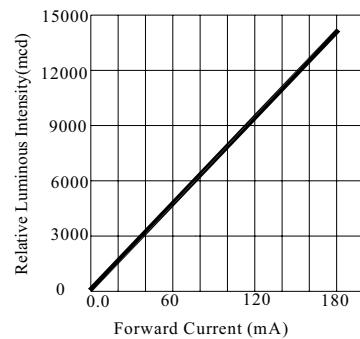


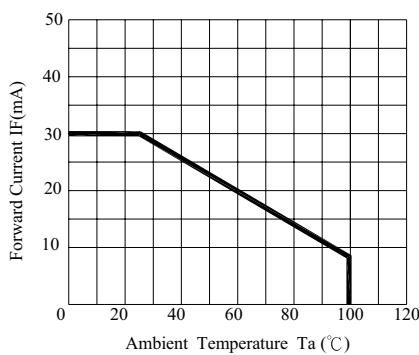
Fig.1 WHITE LED Spectrum VS. WAVELENGTH



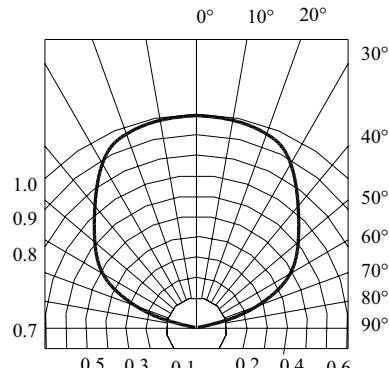
Forward Current VS. Applied Voltage



Forward Current VS. Luminous Intensity



Ambient Temperature VS. Forward Current



Radiation Diagram

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Storage:

Recommended storage environment:

- Temperature: 5°C~30°C (41°F~86°F)
- Humidity: 60% RH Max.
- Moisture measures: Please refer to Moisture-sensitive label on reels package bags. If unused LEDs remain, they should be stored in moisture proof packages, such as a sealed container with packages of moisture absorbant material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal it again (fold the open bag firmly shut and keep in a dry environment).

Soldering:

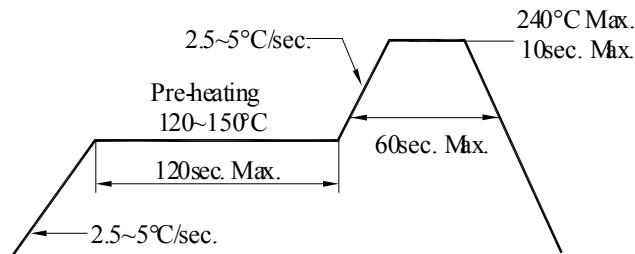
Reflow Soldering			Hand Soldering	
	Lead Solder	Lead-free Solder		
Pre-heat	120 ~ 150°C	180 ~ 200°C	Temperature	350°C Max.
Pre-heat Time	120sec. Max.	120sec. Max.	Soldering Time	
Peak Temperature	240°C Max.	260°C Max.		
Soldering Time	10sec. max.	10sec. Max.		3sec. Max. (one time only)
Condition	Refer to Temperature-profile 1	Refer to Temperature-profile 2		

* After reflow soldering rapid cooling should be avoided.

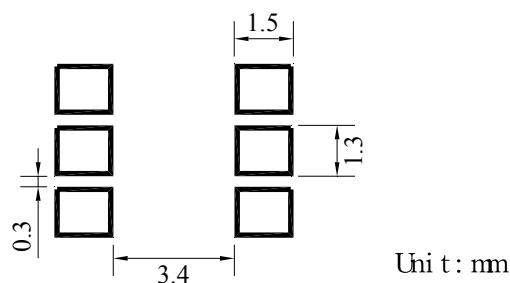
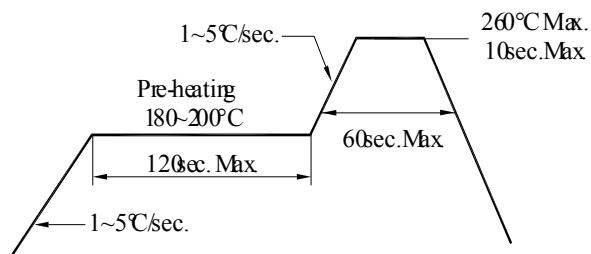
Temperature-profile (Surface of circuit board):

Use the following conditions shown in the figure.

<1 : Lead Solder>



<2 : Lead-free Solder>



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